



## **HVCF SERIES**

2.5 to 10kV, 0.65 to 1.50A, 75nS Axial Lead Power Diodes



- High Current and Fast Recovery
- Glass Passivated
- Molded Plastic Body, ANSI/UL94 V-0 Rated Material

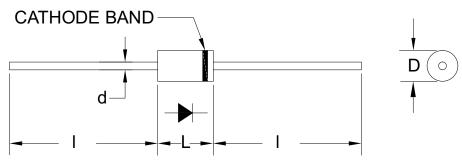
### Specifications<sup>1</sup>

Part Number	V <sub>RRM</sub> V	I <sub>FAVM1</sub> 2 mA	I <sub>FAVM2</sub> 2 mA	V <sub>F</sub> V	l <sub>R</sub> μΑ	I <sub>FSM</sub>	C <sub>J</sub> pF	T <sub>RR</sub> nS	L in.	D in.	d in.	l in.
HVCF25	2500	1500	3000	4.3	2	200	65	75	0.38	0.32	0.08	0.60
HVCF50	5000	1200	2200	7.0	2	150	45	75	0.38	0.32	0.08	0.60
HVCF100	10000	650	1500	10.7	2	100	24	75	0.38	0.32	0.08	0.60

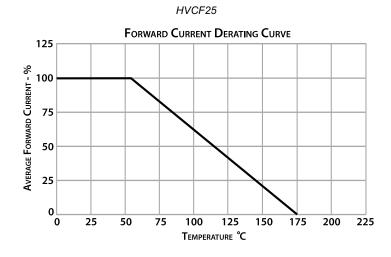
Temperature °C					
Operating Temperature	-55 to 175 (HVCF25) -55 to 150 (HVCF50, HVCF100)				
Storage Temperature	-55 to 175				
Maximum Junction Temperature	175 (HVCF25) 150 (HVCF50, HVCF100)				

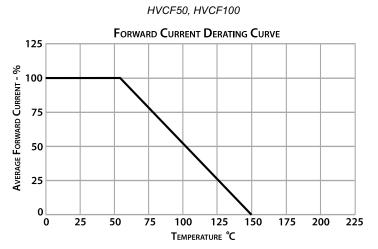
<sup>&</sup>lt;sup>1</sup>25°C ambient temperature unless stated otherwise.

#### **Drawings**



Dimensions in inches, tolerances  $\pm 0.020$  except as noted





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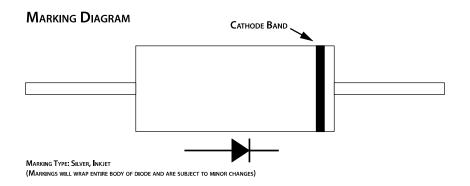
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<sup>&</sup>lt;sup>2</sup>Check Specification Definitions for conditions details.



# **HVCF SERIES**



#### **Specification Definitions**

	Specifications	Conditions
$V_{RRM}$	Maximum Repetitive Reverse Voltage	-
I <sub>FAVM1</sub>	Maximum Average Forward Current	At T <sub>A</sub> = 55°C
I <sub>FAVM2</sub>	Maximum Average Forward Current	At $T_L = 55^{\circ}C$
V <sub>F</sub>	Maximum Forward Voltage Drop	At I <sub>FAVM1</sub>
I <sub>R</sub>	Maximum Leakage Current	At V <sub>RRM</sub>
I <sub>FSM</sub>	Maximum Surge Current	At 8.3mS, Single Half Sine
CJ	Typical Junction Capacitance	At $V_R = 0$ VDC, $f = 1$ MHz
T <sub>RR</sub>	Maximum Reverse Recovery Time	$I_F = 500 \text{mA}$ ; $I_R = -1000 \text{mA}$ ; $I_{RR} = -250 \text{mA}$

Note: Specifications subject to change without notice. Photo is representation only.



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